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NOT RECOMMENDED FOR NEW DESIGN

USE AP3428



High Efficiency Step-Down Low Power DC-DC Converter

The AP6015 is the first device in a family of low-noise current

mode synchronous step-down DC-DC converters. It is ideally

suited for systems powered by either a 1-cell Li-ion battery or a 2-

The AP6015 is a synchronous PWM converter with integrated N- and P-channel power MOSFET switches. Compared to the

asynchronous topology, synchronous rectification offers the benefits of higher efficiency and reduced component count. The high operating frequency of 1MHz allows small inductor and capacitor to be used. This results in small pcb area. During shut-down, the standby current drops to 1 μ A or less. The AP6015 is available in the 10-pin MSOP package. It operates

over a free-air temperature range of -40°C to 85°C.

General Description

to 3-cell NiCd/ NiMH/ Alkaline battery.

AP6015

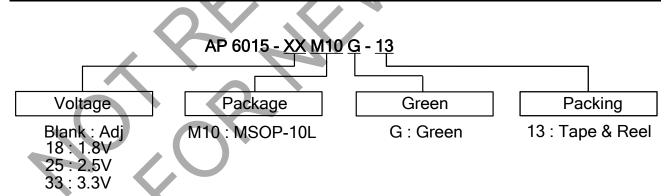
Features

- High efficiency synchronous step-down converter with greater than 94%
- Current Mode Operation for faster transient response
 and better loop stabilization
- 2.5V to 5.5V operating input voltage range
- Adjustable output voltage range from 0.8V to VIN
- Fixed output voltage options: 1.8V, 2.5V and 3.3V
- Up to 800mA output current
- High efficiency over a wide range of load currents
- PWM operation mode
- Internal soft-start function
- Typical quiescent current of 150µA
- MSOP-10L: Available in "Green" Molding Compound (No Br, Sb)
- Lead Free Finish/ RoHS Compliant (Note 1)

Applications

- Mobile Handsets
- PDAs, Ultra Mobile PCs
- Portable Media Players, Digital Still/Video Cameras
- USB-based DSL Modems
- LAN/WLAN/WPAN/WWAN Modules

Ordering Information

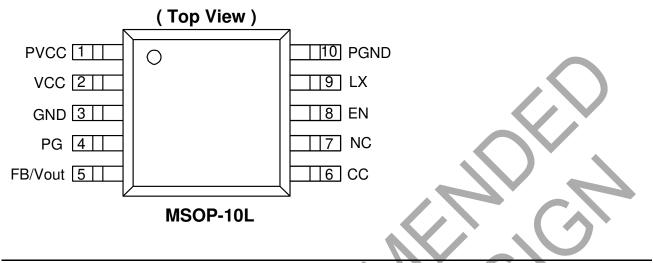


Dovior	Device		Packaging	13" Tape and Reel		
Device			(Note 2)	Quantity	Part Number Suffix	
AP6015-XXM10)G-13	M10	MSOP-10L	2500/Tape & Reel	-13	

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see *EU Directive 2002/95/EC Annex Notes*. 2. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.



Pin Assignment

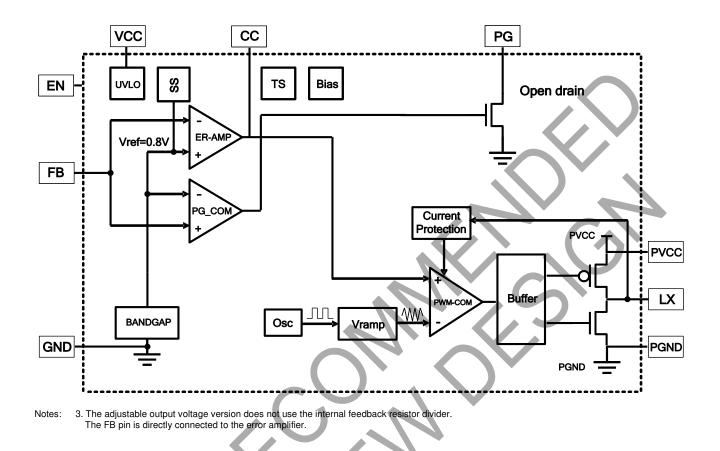


Pin Descriptions

Pin Name	Pin NO.	I/O	Description			
PVCC	1	I	Supply voltage input			
VCC	2		Supply bypass pin. A $1\mu F$ coupling capacitor should be connected as close as possible to this pin.			
GND	3		Ground			
PG	4	0	Power good comparator output. A pull-up resistor should be connected between PG and V_0 .			
FB	5	1	Feedback pin for the fixed output voltage option.			
CC	6	I	Compensation pin			
NC	7	NC	No connect			
EN	8		Enable.Pin, H: Enable. L:shutdown			
LX	9	I/O	Connect the inductor to this pin.			
PGND	10		Power ground			



Block Diagram



Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2.5	KV
ESD MM	Machine Model ESD Protection	300	V
	Supply Voltage	-0.3 to +5.5	V
	Voltages on pins EN, CC, PG, FB, LX	-0.3 to V _{IN} +0.3	V
T _{J(MAX)}	Maximum Junction Temperature Range	+150	°C
T _{ST}	Storage temperature range	-65 to +150	°C
T _{OP}	Operating Junction Temperature Range	-40 to +125	°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods ma affect device reliability.



Recommended Operating Conditions (T_A :-40~85°C)

Symbol	Parameter	Rating	Unit
T _A	Operating Ambient Temperature Range	-40 to +85	°C
V _{IN}	Supply Voltage	2.0 to 5.5	V
Vo	Output voltage range for adjustable output voltage version	0.8 to V _I	V
L	Inductor (see Note 4)	3.3	μH
Ci	Input capacitor (see Note 4)	10	μF
Co	Output capacitor (see Note 4) $V_{\rm O} \ge 1.8V$	10	μF

Notes: 4. Refer to application section for further information.

Electrical Characteristics (T_A =25°C)

Over recommended operating free-air temperature range, VI=3.6V, VO=2.5V, IO=300mA, EN=VIN. (unless otherwise noted)								
Symbol	Paramete	r	Conditions	Min	Тур.	Max	Unit	
Supply cur	rent					•		
		-20 to 85 °C	I _O = 0mA to 800mA	2.5	-	5.5	V	
V _{IN}		-20 10 65 0	I _O = 0mA to 500mA	2	-	5.5		
VIN	Input Voltage range	40 to 95 °C	I _O = 0mA to 600mA	2.5		5.5		
		-40 to 85 °C	Io= 0mA to 400mA	2	-	-		
lccq	Operating quiescent current		I _O = 0mA	-	150	-	μA	
I _{STBY}	Standby current		EN= GND	-	0.1	1	μA	
Enable		\sim .						
V			V _{IN} ≤ 3V	1.5	-	-	V	
V _{IH}	EN high-level input volta	ge	V _{IN} > 3V	2.5	-	-	v	
VIL	EN low-level input voltag	le		-	-	0.7	V	
١L	EN input leakage current		EN= GND or V _{IN}	-	0.01	0.1	μA	
V _(UVLO)	Under-voltage-lockout-th	ireshold		1.2	1.6	1.95	V	



Electrical Characteristics (Continued)

Over recommended operating free-air temperature range, V	/I=3.6V, Vo=2.5V, Io=300 mA, EN=VIN	(unless o	otherwise	noted)
even recommended operating nee an temperature range,		(41100000		notou)

Symbol	Para	meter	Conditions	Min	Тур.	Max	Unit
Power swit	tch and current lim	it	1				
	P-channel MOSF	ET on-resistance	V _I =V _{GS} =3.6V; I=200mA V _I =V _{GS} =2V; I=200mA	200	280 480	410	mΩ
D	P-channel leakage	e current	V _{DS} =5.5V	-	-	T	μA
$R_{\text{DS(on)}}$	N-channel MOSF	ET on-resistance	V _I =V _{GS} =3.6V; I _O =200mA V _I =V _{GS} =2V; I _O =200mA	200	280 500	410	mΩ
	N-channel leakag	e current	V _{DS} =5.5V	-		1	μA
I _(LIM)	P-channel current limit		2.5V≤V₁≤5.5V	1200	+	1600	mA
Power goo	d output (see Note	e 5)	-				
V _(PG)	Power good thres	hold	Feedback voltage falling	88% Vo	92% Vo	94% Vo	V
(-)	Power good hyste	eresis			2.5% Va		
V_{OL}	PG output low vol	tage	$V_{(FB)}=0.8 \times V_{O}$ nominal; $I_{(sink)}=10 \mu A$			0.3	V
LKG	PG output leakage	e current	V _(FB) =V _O nominal		0.01	1	μA
	Minimum supply voltage for valid power good signal			1.2		-	V
Oscillator							
Fs	Oscillator frequen	су		800	1000	1200	KHz
Output							
Vo	Adjustable output			0.8		5.5	V
V_{REF}	Reference voltage			0.784	0.8	0.816	V
		AP6015-Adj AP6015-1.8V	V _I =2.5V to 5.5V; 0mA ≤ I _O ≤ 800mA	-3%	-	4%	
		AI 0013-1.0V	10mA ≤ I ₀ ≤ 800mA	-3%	-	3%	
Vo	Fixed output voltage	AP6015-2.5V	V _I =2.7V to 5.5V; 0mA ≤ I _O ≤ 800mA	-3%	-	4%	V
	(see Note 6)		10mA ≤ I ₀ ≤ 800mA	-3%	-	3%	
		AP6015-3.3V	V _I =3.6V to 5.5V; 0mA ≤ I _O ≤ 800mA	-3%	-	4%	
			10mA ≤ I ₀ ≤ 800mA	-3%	-	3%	
•	Line regulation		V _I = V ₀ +0.5V (min.2V) to 6.0V; I₀=10mA		0.3		%/V
7	Load regulation	\mathbf{O}	V _I =5.0V; I _O =10mA to 800mA		0.8		%
η	Efficiency		V _I =5V; V ₀ =3.3V; I ₀ =300mA V _I =3.6V; V ₀ =2.5V; I ₀ =200mA	94		%	
	Start-up time		$I_{O}=0$ mA, time from active EN to V _O	0.4	1	4	ms
θ_{JA}	Thermal Resistan Junction-to-Ambie		MSOP-10L (Note 7)		161		°C/W
θ_{JC}	Thermal Resistand Junction-to-Case	ce	MSOP-10L (Note 7)		39		°C/W

5. Power good is not valid for the first 100µs after EN goes high. Please refer to the application section for more information. Notes:

6. The output voltage accuracy includes line and load regulation over the full temperature range.
 7. Test condition for MSOP-10L: Device mounted on 2oz copper, minimum recommended pad layout on top & bottom layer with thermal vias, double sided FR-4 PCB

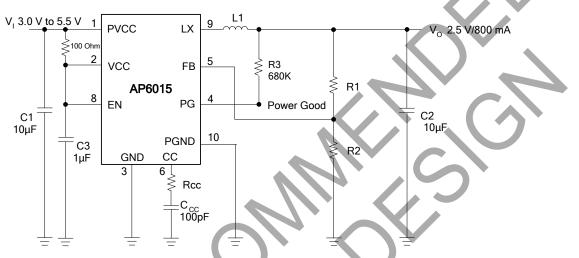


Typical Application Circuit

For best transient response we suggest that R_{CC} , C_{CC} and L1 values as below.

	Rcc	Ccc	L1-WURTH	C1, C2 (MLCC)
$V_{IN} < 3.0V, V_{OUT} < 2.5V$	200ΚΩ	33PF	1.8µH	10µF
$V_{IN} \ge 3.0V, V_{OUT} < 2.5V$	68KΩ	100PF	1.8µH	10µF
$V_{\text{IN}} \ge 3.0V, V_{\text{OUT}} \ge 2.5V$	82KΩ	100PF	3.3µH	10µF

(1) ADJ Output



R2: Suggest to be 39K~100K because of stability reasons.

 $V_O = V_{REF} \times (1 + \frac{R_1}{R_2})$

Typical Application Circuit for Adjustable Output Voltage Option

(2) FIXED Output Typical Application L1 PVCC 9 LX V_o 1.8/ 2.5/ 3.3V/ 800mA V, 5 V ≶ 100 Ohm 5 2 VCC FB R3 AP6015 C2 C1 680K 10uF 4 ۶ 10uF ΕN PG Power Good C3 1uF 10 PGND GND CC 3 6 Rcc ≶ \mathbf{C}_{CC} 100pF --





Typical Operating Characteristics

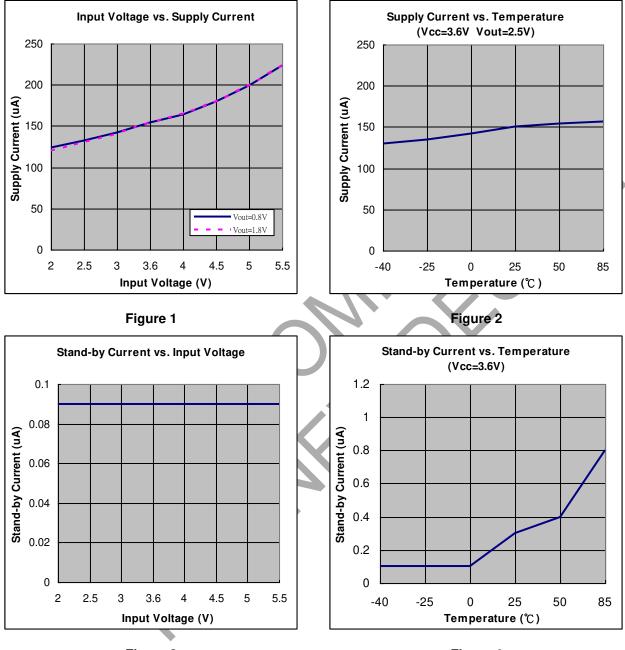


Figure 3

Figure 4



Typical Operating Characteristics (Continued)

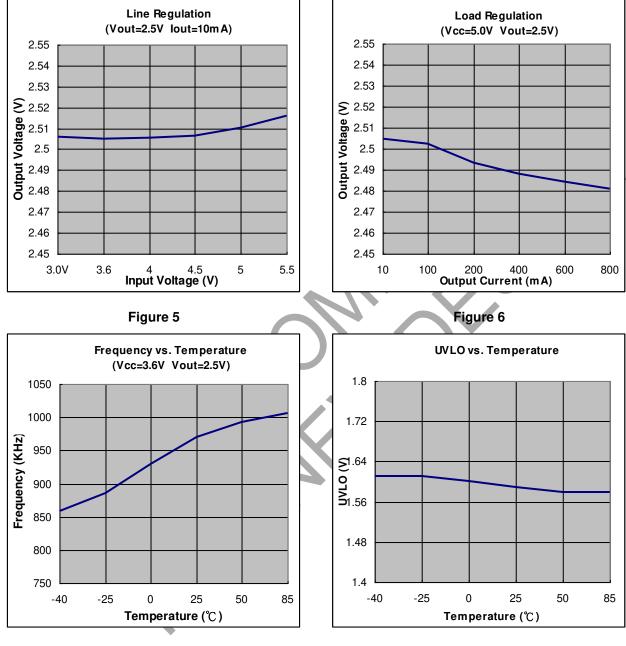


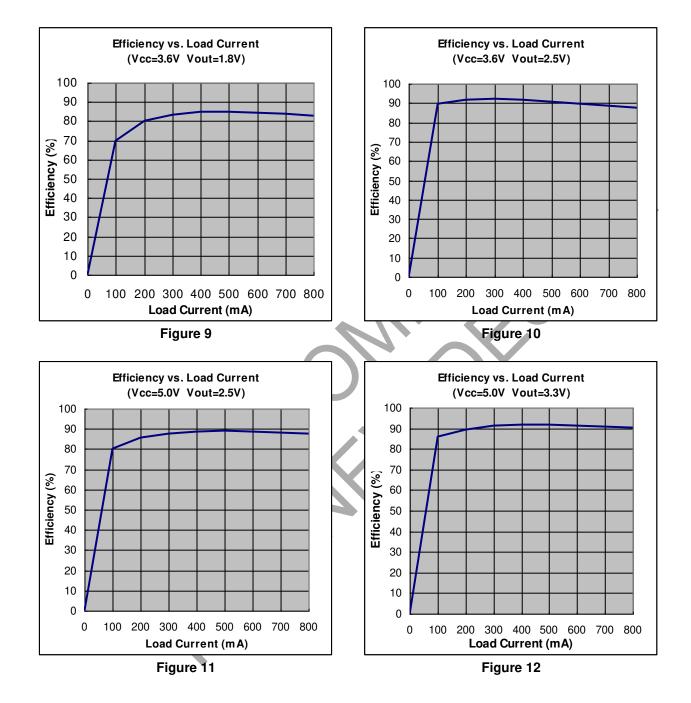
Figure 7

Figure 8



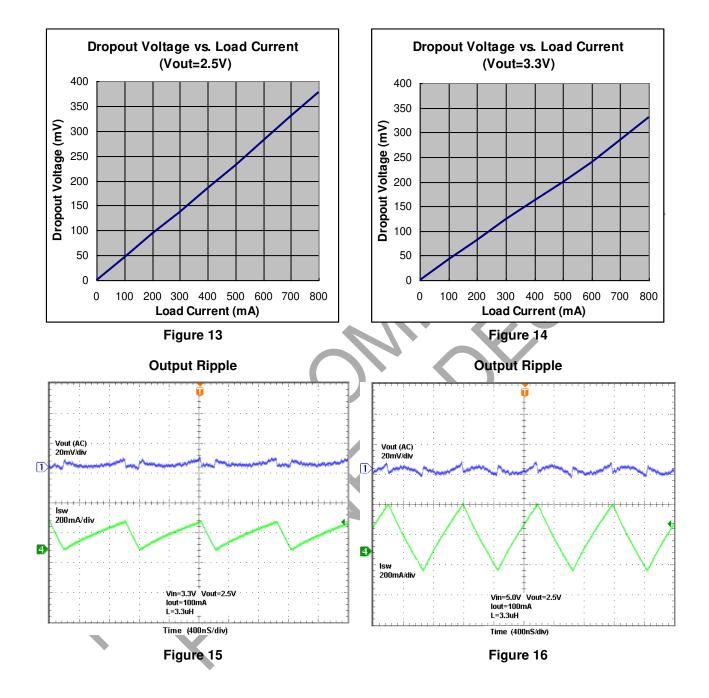
AP6015

Typical Operating Characteristics (Continued)





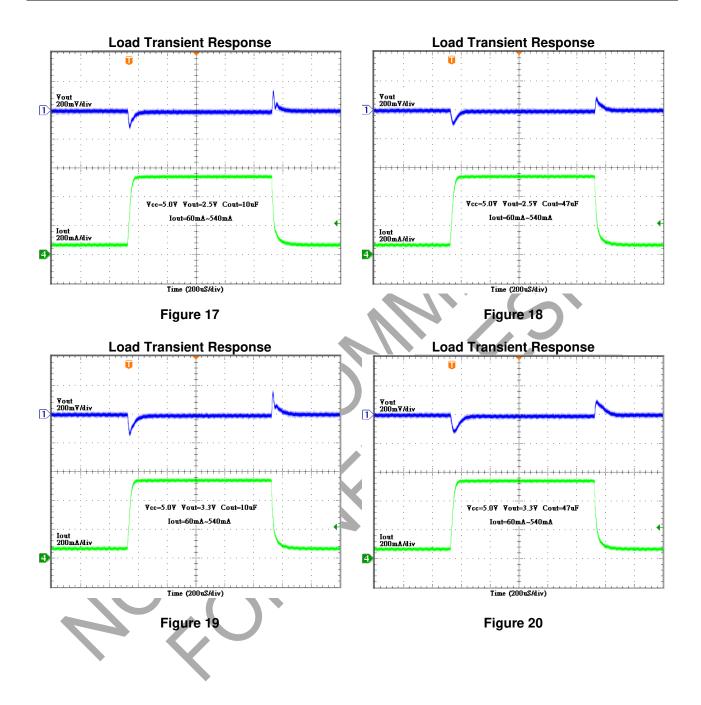
Typical Operating Characteristics (Continued)





AP6015

Typical Operating Characteristics (Continued)





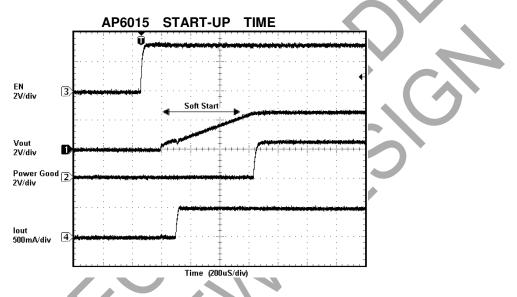
Application Information

■ Enable (EN)

When EN is on logic low, the AP6015 goes into shutdown mode. In shutdown, all other functions are turned off. The supply current is reduced to 1uA (Typ.).

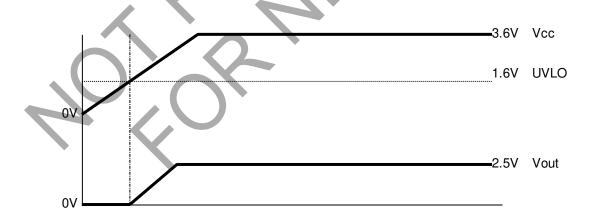
Soft Start

As the enable pin goes high, the soft-start function generates an internal voltage ramp. This causes the start-up current to slowly raise preventing output voltage overshoot and high inrush currents. The soft-start duration is typical 1mSec.



■ Under Voltage Lock Out (UVLO)

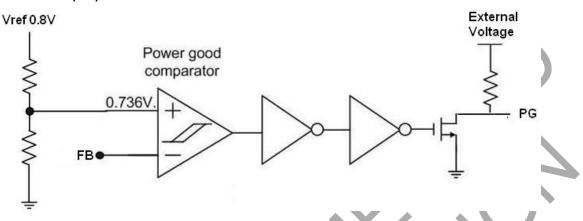
The UVLO prevents the converter from turning on when the voltage on V_{cc} is less than typically 1.6V.





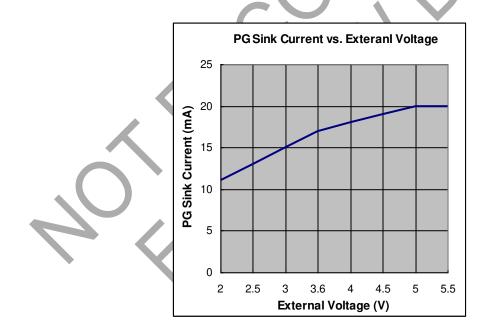
Application Information (Continued)

■ Power Good (PG)



The PG comparator has an open drain output capable of sinking typically 10mA. The PG is only active when the AP6015 is enable (EN=high). When the AP6015 is disable (EN=low), the PG pin is high impedance. If the PG pin is connected to the output of the AP6015 with a pull-up resistor, no initial spike occurs and precautions have to be taken during start-up.

The PG pin becomes active high when the output voltage exceeds typically 92% of its nominal value. Leave the PG pin unconnected when not used.





Application Information (Continued)

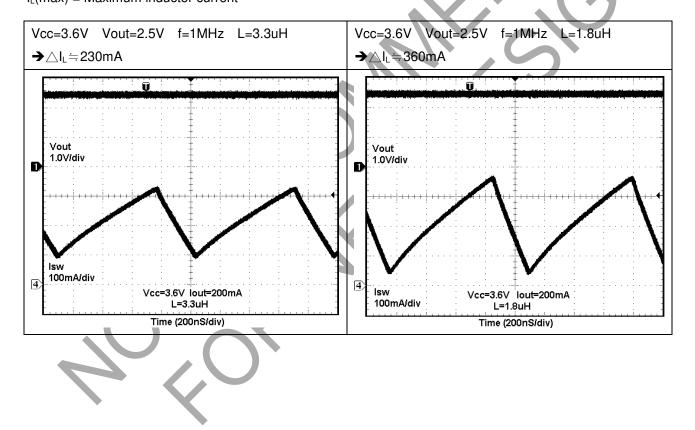
Inductor Selection

In order to avoid saturation of the inductor, the inductor should be rated at least for the maximum output current plus the inductor ripple current which is calculated as:

$$\Delta I_{L} = V_{O} \times \frac{1 - (\frac{V_{O}}{V_{CC}})}{L \times f} \qquad I_{L(MAX)} = I_{O(MAX)} + \frac{\Delta I_{L}}{2}$$

Where:

 $f= Switching frequency (1MHz typical) \\ L = Inductor value \\ \triangle I_L = Peak-to-peak inductor ripple current \\ I_L(max) = Maximum inductor current$





Application Information (Continued)

Input Capacitor Selection

Though there is no special requirement for the ESR (Equivalent Series Resistance) of the input capacitor, due attention should be paid to the tolerance and temperature coefficient of the capacitor used. A 10uF or larger capacitance is required between the PVCC and the GND pins. The input capacitor should be placed as close as possible to the PVCC pin in order to achieve good overall system performance.

Output Capacitor Selection

 \mathbf{V}

Ripple at the voltage output pin is caused by the charge-and-discharge of the output capacitor. For the best performance, a low ESR output capacitor should be used. The equation below demonstrates how the size of the ripple can be calculated.

$$\Delta V_o = V_o \times \frac{1 - (\frac{V_o}{V_{CC}})}{L \times f} \times (\frac{1}{8 \times C_o \times f} + ESR) = \Delta I_L \times (\frac{1}{8 \times C_o \times f} + ESR)$$

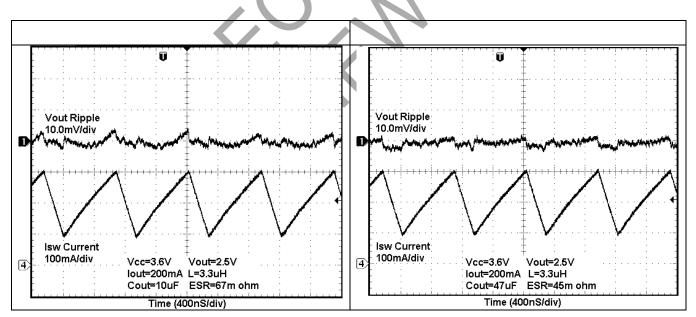
Where:

 \triangle Vo= Output voltage ripple

L = Inductor value

f = Switching frequency (1MHz typical)

 $\triangle I_L$ = Peak-to-peak inductor ripple current

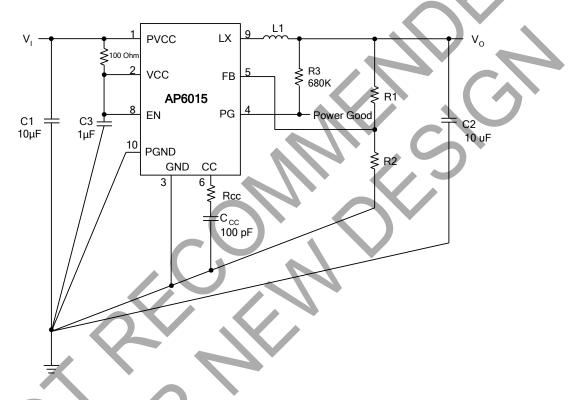




Application Information (Continued)

Layout Considerations

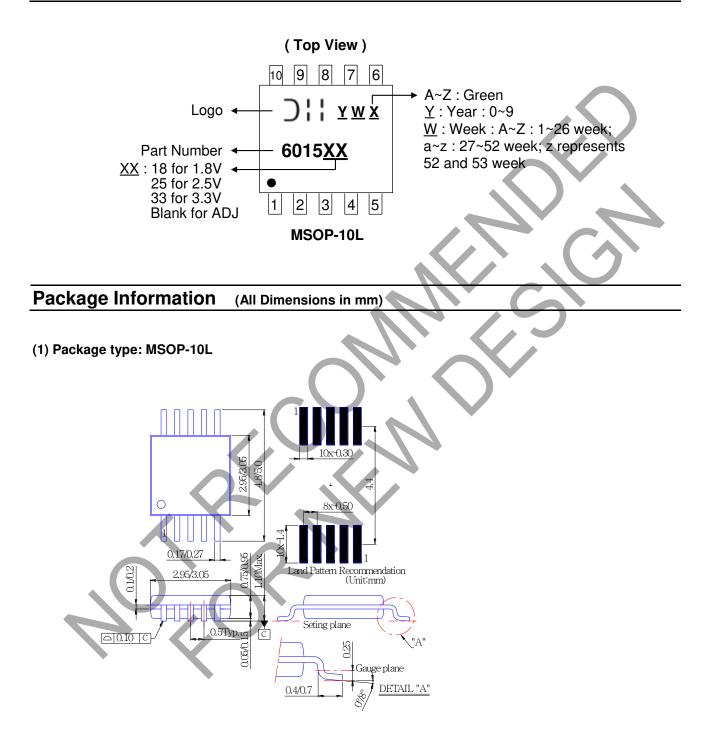
A good board layout practice can significantly improve the stability of the application circuit and reduce the system noise. The feedback path must be as short as possible. The input capacitor and bypass capacitor must be placed close to the PVCC and the VCC pins for optimal performance. It is recommended that the ground planes for System Ground / Power Ground / Analog Ground are isolated from each others, while they should all be joined together at a common point. An example drawing of a circuit with good ground noise performance is shown below.



The external inductor must be placed as close as possible to the switching node, i.e. the LX pin. The copper traces on the pcb, where high peak switching current may flow through, should be kept 'wide' and 'short'. This results in low inductance and capacitance in the current path, hence ground shift problem is avoided and system stability stay within bound.



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